

2SJ244

Silicon P Channel MOS FET

REJ03G0853-0200
(Previous: ADE-208-1187)
Rev.2.00
Sep 07, 2005

Description

High speed power switching

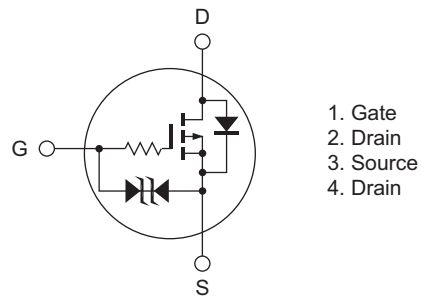
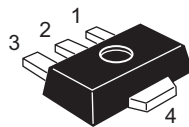
Low voltage operation

Features

- Very Low on-resistance
- High speed switching
- Suitable for camera or VTR motor drive circuit, power switch, solenoid drive and etc.

Outline

RENESAS Package code: PLZZ0004CA-A
(Package name: UPAK®)



Note: Marking is "JY".

*UPAK is a trademark of Renesas Technology Corp.

Absolute Maximum Ratings

(Ta = 25°C)

Item	Symbol	Value	Unit
Drain to source voltage	V _{DSS}	-12	V
Gate to source voltage	V _{GSS}	±7	V
Drain current	I _D	±2	A
Drain peak current	I _{D (pulse)} ^{Note 1}	±4	A
Channel dissipation	P _{ch} ^{Note 2}	1	W
Channel temperature	T _{ch}	150	°C
Storage temperature	T _{stg}	-55 to +150	°C

Notes: 1. PW ≤ 100 μs, duty cycle ≤ 10%

2. Value on the alumina ceramic board (12.5 × 20 × 0.7 mm)

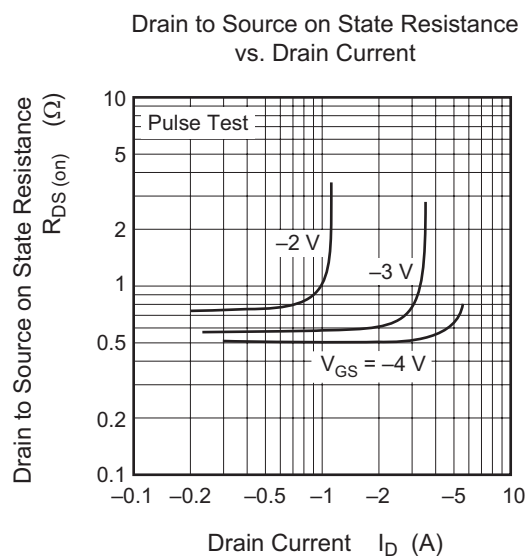
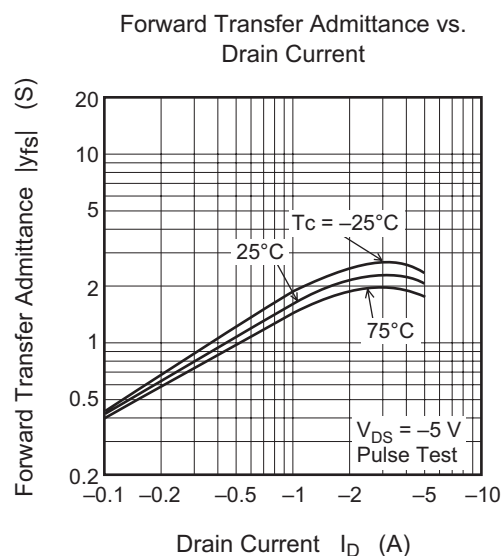
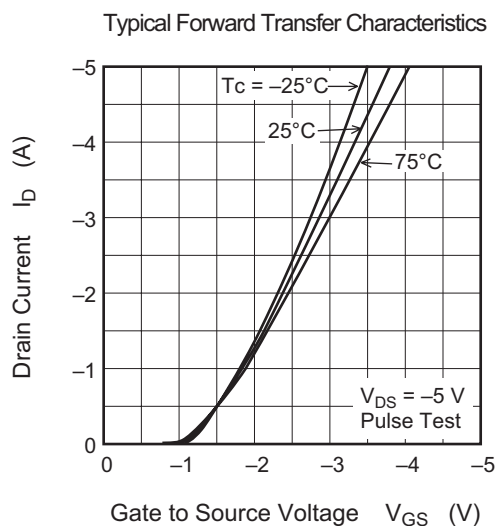
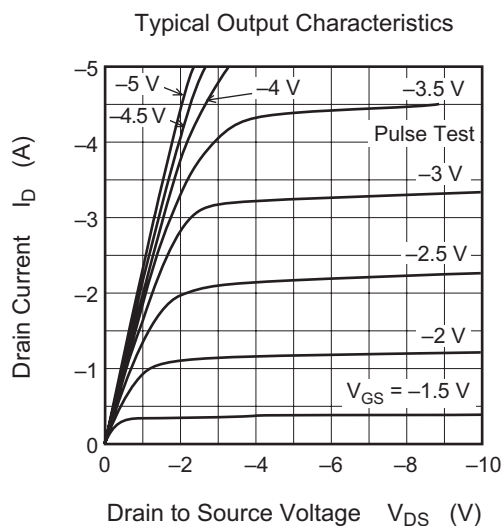
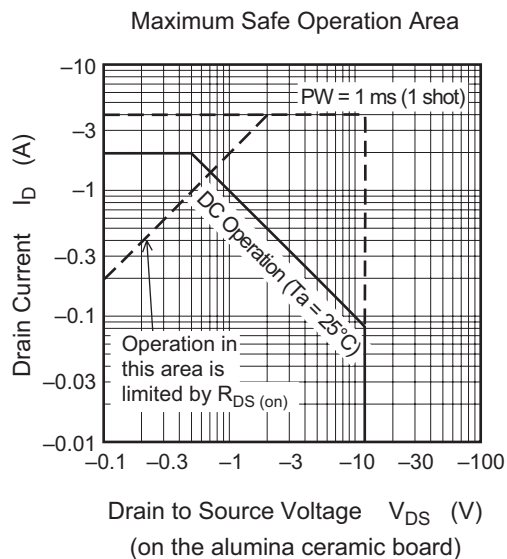
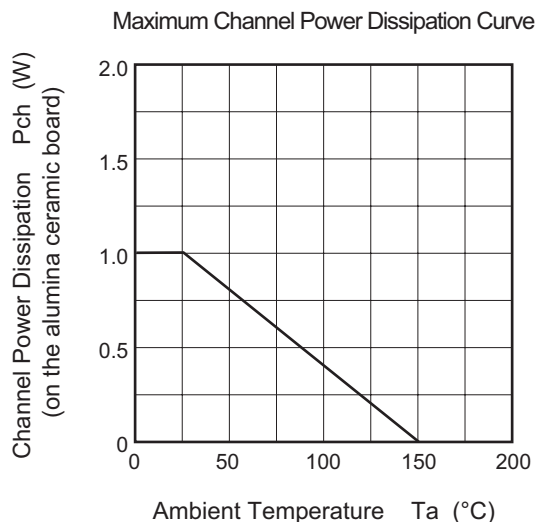
Electrical Characteristics

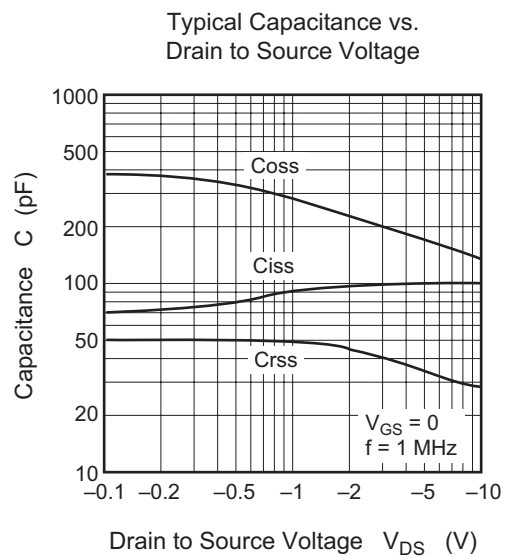
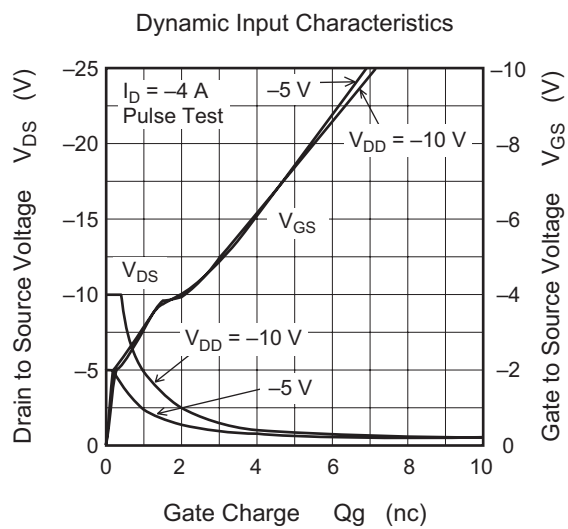
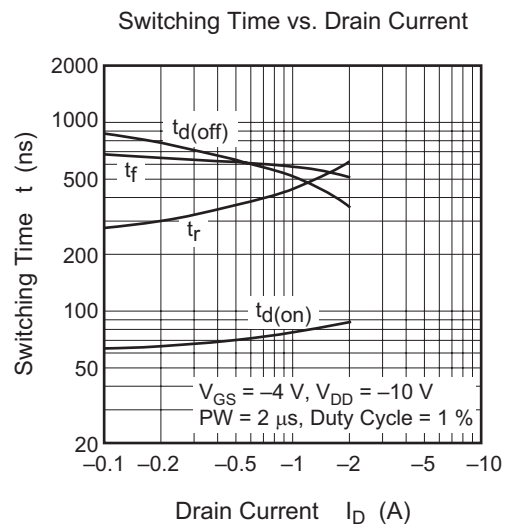
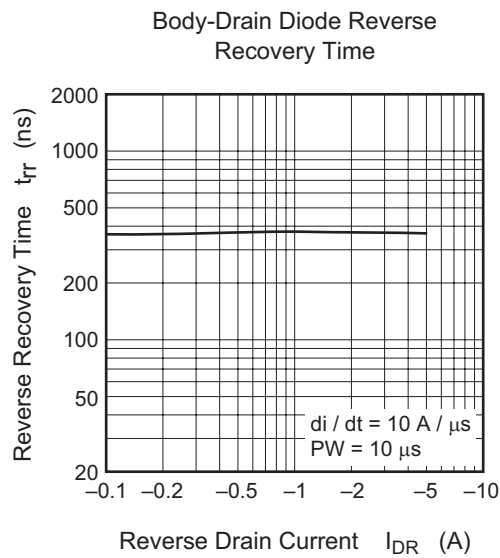
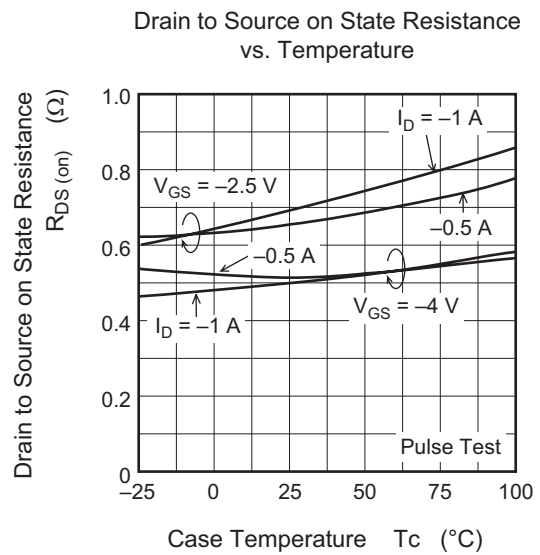
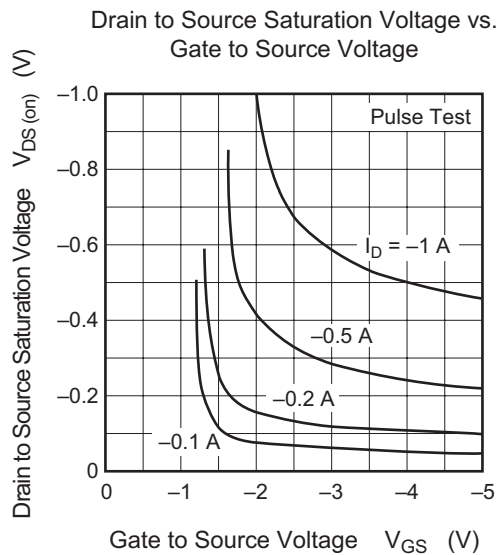
(Ta = 25°C)

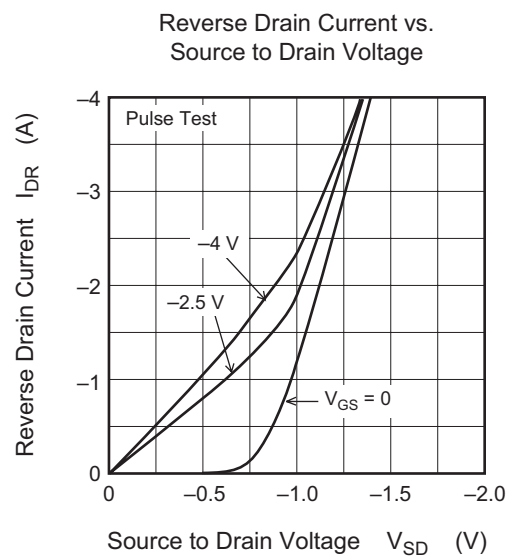
Item	Symbol	Min	Typ	Max	Unit	Test Conditions
Drain to source breakdown voltage	V _{(BR) DSS}	-12	—	—	V	I _D = -1 mA, V _{GS} = 0
Gate to source breakdown voltage	V _{(BR) GSS}	±7	—	—	V	I _G = ±10 μA, V _{DS} = 0
Gate to source leak current	I _{GSS}	—	—	±5	μA	V _{GS} = ±6 V, V _{DS} = 0
Zero gate voltage drain current	I _{DSS}	—	—	-1	μA	V _{DS} = -8 V, V _{GS} = 0
Gate to source cutoff voltage	V _{GS (off)}	-0.4	—	-1.4	V	I _D = -100 μA, V _{DS} = -5 V
Static drain to source on state resistance	R _{DS (on) 1}	—	0.65	0.9	Ω	I _D = -0.5 A, V _{GS} = -2.5 V ^{Note 3}
	R _{DS (on) 2}	—	0.5	—	Ω	I _D = -1 A, V _{GS} = -4 V ^{Note 3}
Forward transfer admittance	y _{fs}	—	1.8	—	S	I _D = -1 A, V _{DS} = -5 V ^{Note 3}
Input capacitance	C _{iss}	—	100	—	pF	V _{DS} = -5 V
Output capacitance	C _{oss}	—	168	—	pF	V _{GS} = 0
Reverse transfer capacitance	C _{rss}	—	35	—	pF	f = 1 MHz
Turn-on delay time	t _{d (on)}	—	365	—	ns	I _D = -0.2 A ^{Note 3}
Turn-off delay time	t _{d (off)}	—	1450	—	ns	V _{in} = -4 V, R _L = 51 Ω
Body to drain diode forward voltage	V _{DF}	—	—	7	V	I _F = 4 A ^{Note 3} , V _{GS} = 0

Note: 3. Pulse test

Main Characteristics







Package Dimensions

JEITA Package Code	RENEAS Code	Package Name	MASS[Typ.]	Unit: mm
SC-62	PLZZ0004CA-A	UPAK / UPAKV	0.050g	

The drawing shows three views of the package:

- Top View:** Overall width is 4.5 ± 0.1 mm. The central mounting pad has a diameter of $\phi 1$ mm. The distance from the center to the side leads is 1.5 ± 0.1 mm. The lead width is 0.53 mm Max and 0.48 mm Max. The distance between the two side leads is 3.0 mm. The distance from the center to the bottom leads is 1.5 mm. The bottom lead width is 0.8 mm Min.
- Side View:** The package height is 1.5 ± 0.1 mm. The lead height is 0.44 mm Max. The distance from the base to the top of the package is 0.4 mm.
- Front View:** The package width is 1.5 mm. The lead width is 0.4 mm. The distance from the base to the top of the package is 0.2 mm.

Ordering Information

Part Name	Quantity	Shipping Container
2SJ244JYTL-E	1000 pcs	Taping
2SJ244JYTR-E	1000 pcs	Taping

Note: For some grades, production may be terminated. Please contact the Renesas sales office to check the state of production before ordering the product.

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